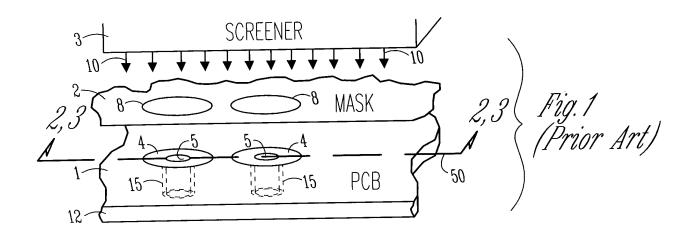
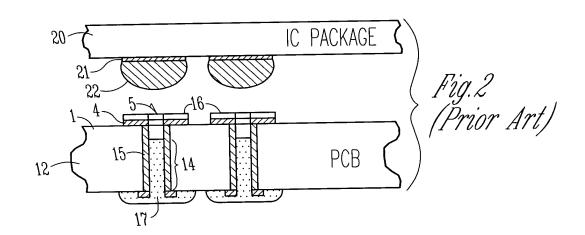
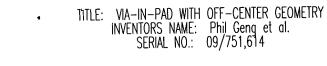
TITLE: VIA—IN—PAD WITH OFF—CENTER GEOMETRY INVENTORS NAME: Phil Geng et al. SERIAL NO.: 09/751,614











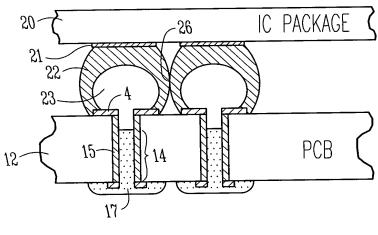
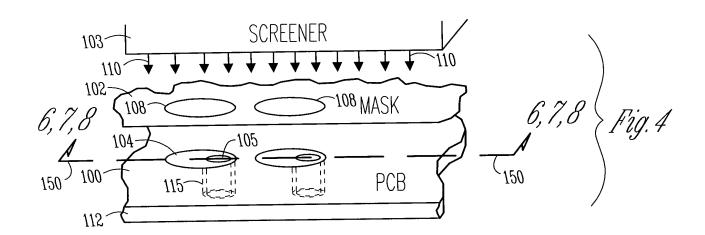
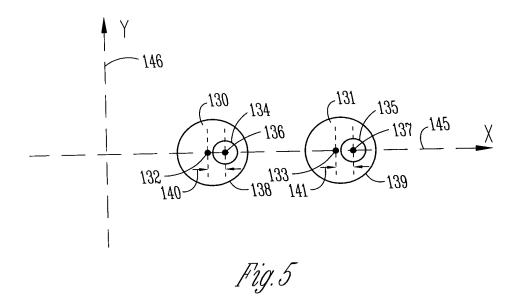


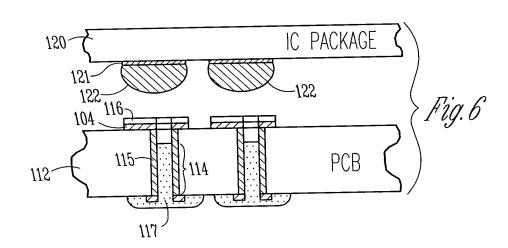
Fig.3 (Prior Art)





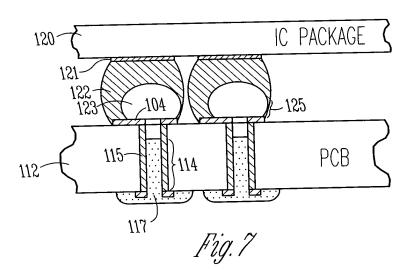
TITLE: VIA-IN-PAD WITH OFF-CENTER GEOMETRY INVENTORS NAME: Phil Geng et al. SERIAL NO.: 09/751,614





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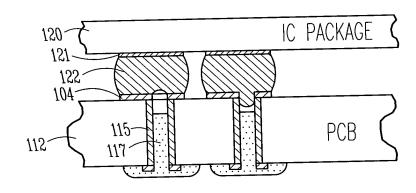
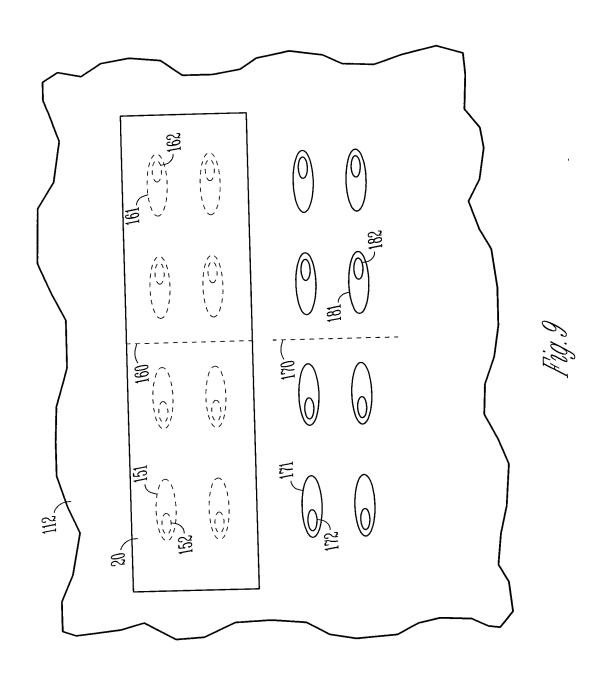


Fig. 8

TYTLE: VIA-IN-PAD WITH OFF-CENTER GEOMETRY INVENTORS NAME: Phil Geng et al. SERIAL NO.: 09/751,614









TITLE: VIA-IN-PAD WITH OFF-CENTER GEOMETRY INVENTORS NAME: Phil Geng et al. SERIAL NO.: 09/751,614

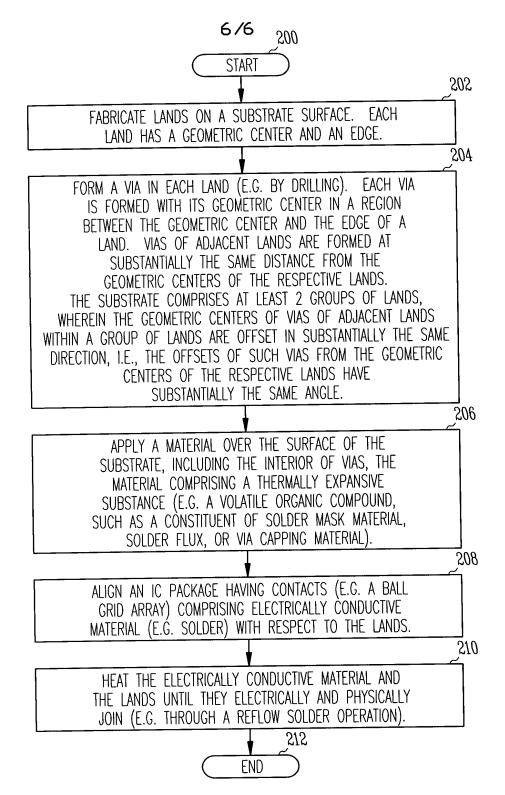


Fig. 10